













Delphi Series Q48SE, Quarter Brick Family DC/DC Power Modules: 38~75V in, 11.8V/33A out, 400W

The Delphi series Q48SE12033, quarter brick, 38~75V input, single output, isolated DC/DC converter is the latest offering from a world leader in power system and technology and manufacturing — Delta Electronics, Inc. This product provides up to 400 watts of power in an industry standard footprint and pin out. With creative design technology and optimization of component placement, these converters possess outstanding electrical and thermal performances, as well as extremely high reliability under highly stressful operating conditions. The Q48SE12033 offers more than 95.5% high efficiency at 33A full load. The Q48SE12033 is fully protected from abnormal input/output voltage, current, and temperature conditions and meets all safety requirements with basic insulation.

FEATURES

- High efficiency: 95.5% @ 11.8V/33A
- Size

57.9x36.8x11.2mm (2.28"x1.45"x0.44") (w/o heat spreader) 57.9*36.8*12.7mm(2.28"*1.45"0.50") (with heat spreader)

- Standard footprint
- Industry standard pin out
- Fixed frequency operation
- Input UVLO, Output OCP, OVP, OTP
- Hiccup output over current protection (OCP)
- Hiccup output over voltage protection (OVP)
- Auto recovery OTP and input UVLO
- 2250V isolation and basic insulation
- No minimum load required
- ISO 9001, TL 9000, ISO 14001, QS9000, OHSAS18001 certified manufacturing facility
- UL/cUL 60950-1 (US & Canada) recognized

OPTIONS

- Latched over voltage protection
- Positive On/Off logic
- Heat spreader available for extended operation.

APPLICATIONS

- Telecom / Datacom
- Wireless Networks
- Optical Network Equipment
- Server and Data Storage
- Industrial / Testing Equipment

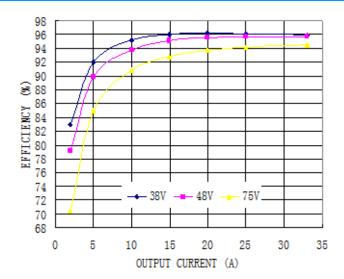


TECHNICAL SPECIFICATIONS

PARAMETER	NOTES and CONDITIONS	Q48	3SE1203	3 (Stand	(Standard)	
ADCOLUTE MAYIMUM DATINGS		Min.	Тур.	Max.	Units	
ABSOLUTE MAXIMUM RATINGS Input Voltage						
Continuous				80	Vdc	
Transient	100ms	10		100	Vdc	
Operating Ambient Temperature Storage Temperature		-40 -55		85 125	°C	
Input/Output Isolation Voltage		-55		2250	Vdc	
INPUT CHARACTERISTICS						
Operating Input Voltage		38	48	75	Vdc	
Input Under-Voltage Lockout Turn-On Voltage Threshold		32.0	34.0	36.0	Vdc	
Turn-Off Voltage Threshold		30.0	32.0	34.0	Vdc	
Lockout Hysteresis Voltage			2		Vdc	
Maximum Input Current	100% Load, 38Vin		470	13	A	
No-Load Input Current Off Converter Input Current	Vin=48V, Io=0A Vin=48V, Io=0A		170 10		mA mA	
Inrush Current (I ² t)	VIII—+0 V, 10—0A		10	1	A ² s	
Input Reflected-Ripple Current	P-P thru 12µH inductor, 5Hz to 20MHz		10		mA	
Input Voltage Ripple Rejection	120 Hz		-30		dB	
OUTPUT CHARACTERISTICS	Vin 40V In 0 To 0500	44.07	44.0	44.00	A / -l.	
Output Voltage Set Point Output Voltage Regulation	Vin=48V, Io=0, Tc=25°C	11.67	11.8	11.92	Vdc	
Output voltage Regulation Over Load	Vin=48V. lo=lo.min to lo.max		±30	±80	mV	
Over Line	Vin=38V to 75V, Io=Io min		±50	_50	mV	
Over Temperature	Vin=48V, Tc=-40°C to 85°C		±100		mV	
Total Output Voltage Range	over sample load, line and temperature	11.44		12.16	Vdc	
Output Voltage Ripple and Noise Peak-to-Peak	5Hz to 20MHz bandwidth Full Load, 1µF ceramic, 10µF tantalum			150	mV	
RMS	Full Load, 1µF ceramic, 10µF tantalum			80	mV	
Operating Output Current Range		0		33	Α	
Output DC Current-Limit Inception	Output Voltage 10% Low	110		140	%	
DYNAMIC CHARACTERISTICS	40\/ 40\/ETop 8 4\/F Coromic load cop 0.4A///					
Output Voltage Current Transient Positive Step Change in Output Current	48V, 10μF Tan & 1μF Ceramic load cap, 0.1A/μs 50% lo.max to 75% lo.max		300		mV	
Negative Step Change in Output Current	75% lo.max to 50% lo.max		300		mV	
Settling Time (within 1% Vout nominal)			300		μs	
Turn-On Transient			70			
Start-Up Time, From On/Off Control Start-Up Time, From Input			70 80		ms ms	
Maximum Output Capacitance	Low ESR CAP (OSCON), 100% load;		00	6000	μF	
EFFICIENCY						
100% Load	Vin=48V		95.5		%	
60% Load ISOLATION CHARACTERISTICS	Vin=48V		95.2		%	
Input to Output				2250	Vdc	
Isolation Resistance		10		2200	ΜΩ	
Isolation Capacitance			1000		pF	
FEATURE CHARACTERISTICS			400		1.11-	
Switching Frequency ON/OFF Control, Negative Remote On/Off logic			160		kHz	
Logic Low (Module On)	Von/off at lon/off=1.0mA	0		0.8	V	
Logic High (Module Off)	Von/off at Ion/off=0.0 μA	2		50	V	
ON/OFF Control, Positive Remote On/Off logic					.,	
Logic Low (Module Off) Logic High (Module On)	Von/off at lon/off=1.0mA Von/off at lon/off=0.0 µA	0 2		0.8 50	V	
ON/OFF Current (for both remote on/off logic)	Ion/off at Von/off=0.0V	2		1	mA	
Leakage Current (for both remote on/off logic)	Logic High, Von/off=15V			50	uA	
Output Over-Voltage Protection	Over full temp range; % of nominal Vout	115		140	%	
GENERAL SPECIFICATIONS	In 2004 of la many To 2500 Ai-flaw 2004 514		4.45		Mina	
MTBF(with heat spreader) Weight(without heat spreader)	lo=80% of lo, max; Tc=25°C;Airflow=300LFM		1.15 50.5		M hours grams	
Weight(with heat spreader)			65.5		grams	
Over-Temperature Shutdown (Without heat spreader)	Refer to Figure 18 for Hot spot 1 location (48Vin,80% lo, 200LFM,Airflow from Vin+ to Vin-)		122		°C	
Over-Temperature Shutdown (With heat spreader)	Refer to Figure 20 for Hot spot 2 location (48Vin,80% lo, 200LFM,Airflow from Vin+ to Vin-)		113		°C	

(T_A=25°C, airflow rate=300 LFM, V_{in}=48Vdc, nominal Vout unless otherwise noted;





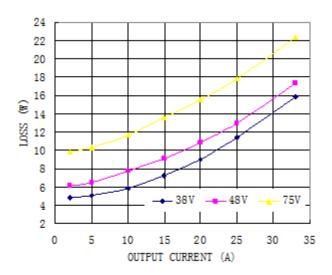


Figure 1: Efficiency vs. load current for minimum, nominal, and maximum input voltage at 85°C.

Figure 2: Power dissipation vs. load current for minimum, nominal, and maximum input voltage at 85°C.

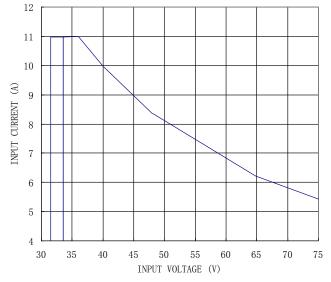
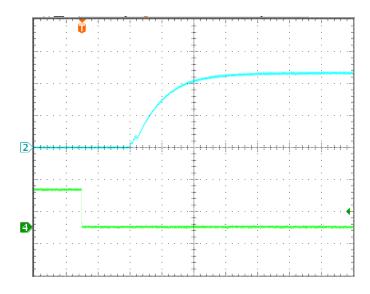


Figure 3: Typical full load input characteristics at room temperature.



For Negative Remote On/Off Logic



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Figure 4: Turn-on transient at zero load current) (20ms/div). Top Trace: Vout; 5V/div; Bottom Trace: ON/OFF input: 2V/div.

Figure 5: Turn-on transient at full rated load current (20 ms/div). Top Trace: Vout: 5V/div; Bottom Trace: ON/OFF input: 2V/div.

For Input Voltage Start up

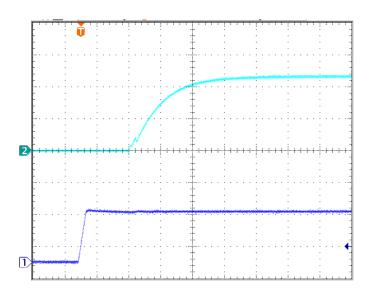


Figure 6: Turn-on transient at zero load current (20 ms/div). Top Trace: Vout; 5V/div; Bottom Trace: input voltage: 30V/div.

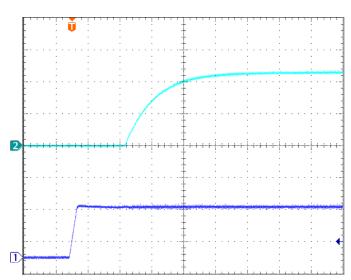
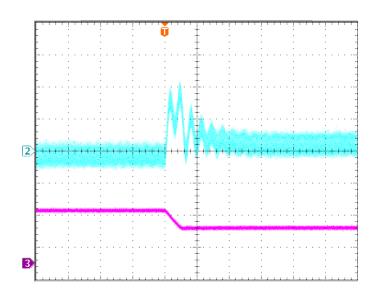


Figure 7: Turn-on transient at full rated load current (20 ms/div). Top Trace: Vout; 5V/div; Bottom Trace: input voltage: 30V/div.

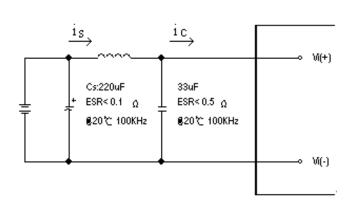




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Figure 8: Output voltage response to step-change in load current (75%-50% of lo, max; di/dt = $0.1A/\mu$ s). Load cap: 10μ F, tantalum capacitor and 1μ F ceramic capacitor. Top Trace: Vout; 100mV/div; Bottom Trace: output current: 15A/div, Time: 200us/div

Figure 9: Output voltage response to step-change in load current (50%-75% of Io, max; di/dt = $0.1A/\mu$ s). Load cap: 10μ F, tantalum capacitor and 1μ F ceramic capacitor. Top Trace: Vout; 100mV/div; Bottom Trace: output current: 15A/div, Time: 200us/div



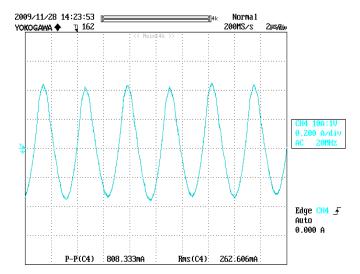
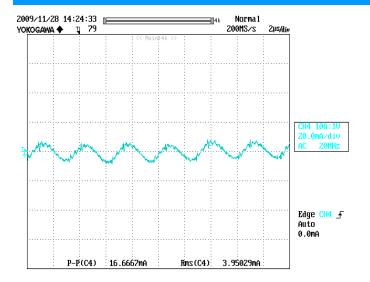


Figure 10: Test set-up diagram showing measurement points for Input Terminal Ripple Current and Input Reflected Ripple Current.

Figure 11: Input Terminal Ripple Current, i_c, at full rated output current and nominal input voltage with 12μH source impedance and 33μF electrolytic capacitor (200 mA/div, 2us/div).

Note: Measured input reflected-ripple current with a simulated source Inductance (L_{TEST}) of 12 μ H. Capacitor Cs offset possible battery impedance. Measure current as shown above.





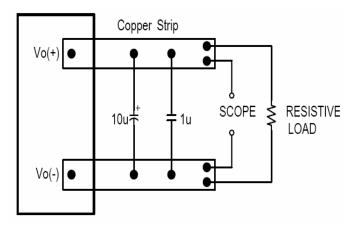


Figure 12: Input reflected ripple current, i_s , through a 12 μ H source inductor at nominal input voltage and rated load current (20 mA/div, 2us/div).

Figure 13: Output voltage noise and ripple measurement test setup.

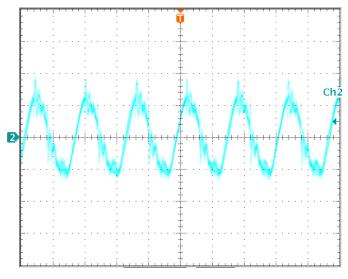


Figure 14: Output voltage ripple at nominal input voltage and rated load current (lo=33A)(20 mV/div, 2us/div) Load capacitance: 1μF ceramic capacitor and 10μF tantalum capacitor. Bandwidth: 20 MHz.

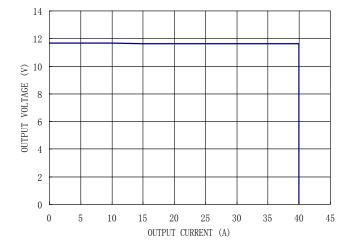


Figure 15: Output voltage vs. load current showing typical current limit curves and converter shutdown points.



DESIGN CONSIDERATIONS

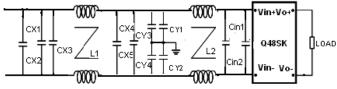
Input Source Impedance

The impedance of the input source connecting to the DC/DC power modules will interact with the modules and affect the stability. A low ac-impedance input source is recommended. If the source inductance is more than a few μ H, we advise 100 μ F electrolytic capacitor (ESR < 0.7 Ω at 100 kHz) mounted close to the input of the module to improve the stability.

Layout and EMC Considerations

Delta's DC/DC power modules are designed to operate in a wide variety of systems and applications. For design assistance with EMC compliance and related PWB layout issues, please contact Delta's technical support team. An external input filter module is available for easier EMC compliance design. Below is the reference design for an input filter tested with Q48SE12033XXXX to meet class B in CISSPR 22

Schematic and Components List



CX1,CX2,CX3,CX4,CX5 is 1000nF ceramic caps; Cin1 is 100nF ceramic cap;

CY1,CY2,CY3,CY4 is 0.22uF ceramic caps;

L1.L2 is common-mode inductor, L1, L2=473uH

Test Result: Vin=48V, Io=33A

Cin2 is 100uF Aluninum cap;



Safety Considerations

The power module must be installed in compliance with the spacing and separation requirements of the end-user's safety agency standard, i.e., UL60950-1, CSA C22.2 NO. 60950-1 2nd and IEC 60950-1 2nd: 2005 and EN 60950-1 2nd: 2006+A11+A1: 2010, if the system in which the power module is to be used must meet safety agency requirements.

Basic insulation based on 75 Vdc input is provided between the input and output of the module for the purpose of applying insulation requirements when the input to this DC-to-DC converter is identified as TNV-2 or SELV. An additional evaluation is needed if the source is other than TNV-2 or SELV.

When the input source is SELV circuit, the power module meets SELV (safety extra-low voltage) requirements. If the input source is a hazardous voltage which is greater than 60 Vdc and less than or equal to 75 Vdc, for the module's output to meet SELV requirements, all of the following must be met:

- The input source must be insulated from the ac mains by reinforced or double insulation.
- The input terminals of the module are not operator accessible.
- A SELV reliability test is conducted on the system where the module is used, in combination with the module, to ensure that under a single fault, hazardous voltage does not appear at the module's output.

When installed into a Class II equipment (without grounding), spacing consideration should be given to the end-use installation, as the spacing between the module and mounting surface have not been evaluated.

The power module has extra-low voltage (ELV) outputs when all inputs are ELV.

This power module is not internally fused. To achieve optimum safety and system protection, an input line fuse is highly recommended. The safety agencies require a normal-blow fuse with 40A maximum rating to be installed in the ungrounded lead. A lower rated fuse can be used based on the maximum inrush transient energy and maximum input current.

Soldering and Cleaning Considerations

Post solder cleaning is usually the final board assembly process before the board or system undergoes electrical testing. Inadequate cleaning and/or drying may lower the reliability of a power module and severely affect the finished circuit board assembly test. Adequate cleaning and/or drying is especially important for un-encapsulated and/or open frame type power modules. For assistance on appropriate soldering and cleaning procedures, please contact Delta's technical support team.



FEATURES DESCRIPTIONS

Over-Current Protection

The modules include an internal output over-current protection circuit, which will endure current limiting for an unlimited duration during output overload. If the output current exceeds the OCP set point, the modules will shut down (hiccup mode).

The modules will try to restart after shutdown. If the overload condition still exists, the module will shut down again. This restart trial will continue until the overload condition is corrected.

Over-Voltage Protection

The modules include an internal output over-voltage protection circuit, which monitors the voltage on the output terminals. If this voltage exceeds the over-voltage set point, the protection circuit will constrain the max duty cycle to limit the output voltage, if the output voltage continuously increases the modules will shut down, and then restart after a hiccup-time (hiccup mode).

There is an option of latch mode. Please contact with Delta if needed.

Over-Temperature Protection

The over-temperature protection consists of circuitry that provides protection from thermal damage. If the temperature exceeds the over-temperature threshold the module will shut down. The module will restart after the temperature is within specification.

Remote On/Off

The remote on/off feature on the module can be either negative or positive logic. Negative logic turns the module on during a logic low and off during a logic high. Positive logic turns the modules on during a logic high and off during a logic low.

Remote on/off can be controlled by an external switch between the on/off terminal and the Vi (-) terminal. The switch can be an open collector or open drain.

For negative logic if the remote on/off feature is not used, please short the on/off pin to Vi (-). For positive logic if the remote on/off feature is not used, please leave the on/off pin to floating.

The on/off signal should be longer than 120us, module will not response to the less than 120us on/off signals. It is better for customer to use on/off signal much longer than 120us, DC level on/off signal is suggested.

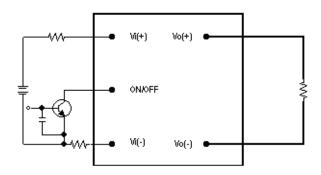


Figure 16: Remote on/off implementation



THERMAL CONSIDERATIONS

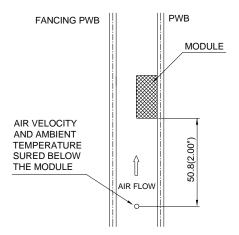
Thermal management is an important part of the system design. To ensure proper, reliable operation, sufficient cooling of the power module is needed over the entire temperature range of the module. Convection cooling is usually the dominant mode of heat transfer.

Hence, the choice of equipment to characterize the thermal performance of the power module is a wind tunnel.

Thermal Testing Setup

Delta's DC/DC power modules are characterized in heated vertical wind tunnels that simulate the thermal environments encountered in most electronics equipment. This type of equipment commonly uses vertically mounted circuit cards in cabinet racks in which the power modules are mounted.

The following figure shows the wind tunnel characterization setup. The power module is mounted on a test PWB and is vertically positioned within the wind tunnel. The space between the neighboring PWB and the top of the power module is constantly kept at 6.35mm (0.25").



Note: Wind Tunnel Test Setup Figure Dimensions are in millimeters and (Inches)

Figure 17: Wind tunnel test setup

Thermal Derating

Heat can be removed by increasing airflow over the module. To enhance system reliability, the power module should always be operated below the maximum operating temperature. If the temperature exceeds the maximum module temperature, reliability of the unit may be affected.



THERMAL CURVES (WITHOUT HEAT SPREADER)

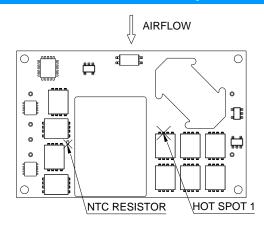


Figure 18: * Hot spot 1& NTC resistor temperature measured points. The allowed maximum hot spot 1 temperature is defined at 117 $^{\circ}$

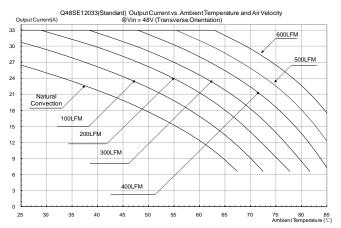


Figure 19: Output current vs. ambient temperature and air velocity @Vin=48V(Transverse Orientation, airflow from Vin+ to Vin-, without heat spreader)

THERMAL CURVES (WITH HEAT SPREADER)

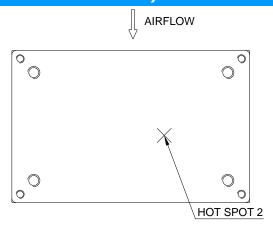


Figure 20: * Hot spot 2 temperature measured point. The allowed maximum hot spot 2 temperature is defined at 108 $\mathcal C$

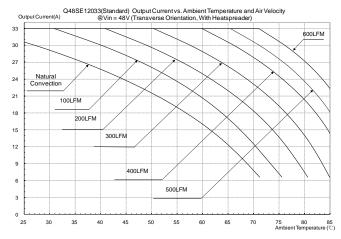
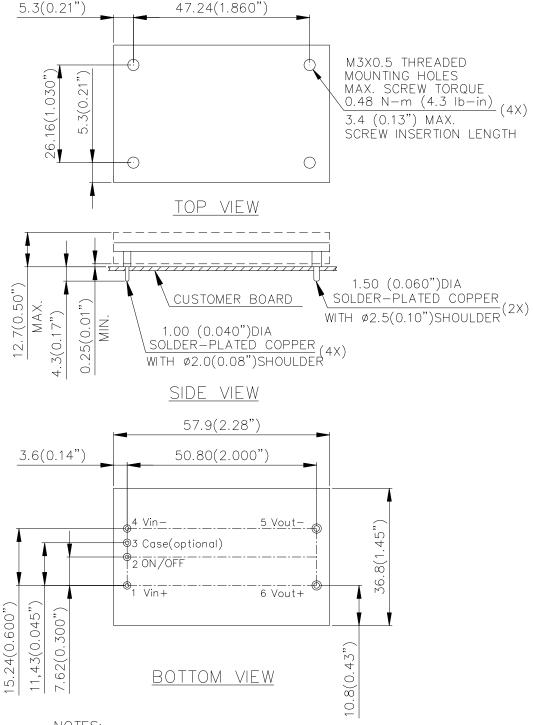


Figure 21: Output current vs. ambient temperature and air velocity @Vin=48V(Transverse Orientation, airflow from Vin+ to Vin-,with heat spreader)



MECHANICAL DRAWING (WITH HEAT SPREADER)

* For modules with through-hole pins and the optional heatspreader, they are intended for wave soldering assembly onto system boards; please do not subject such modules through reflow temperature profile.

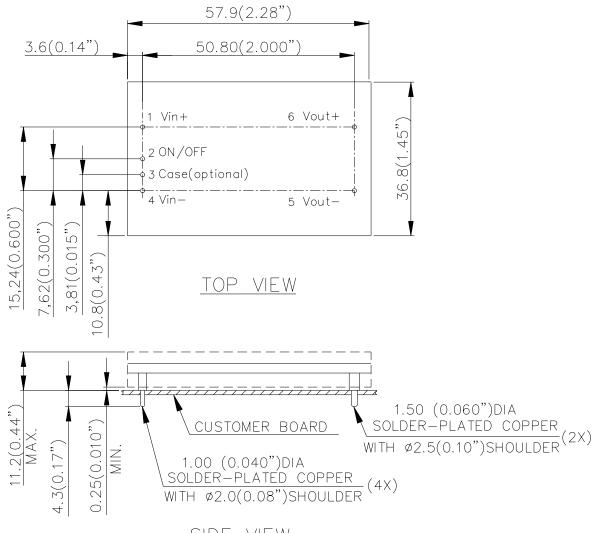


NOTES:

DIMENSIONS ARE IN MILLIMETERS AND (INCHES)
TOLERANCES: X.Xmm±0.5mm(X.XX in.±0.02 in.)
X.XXmm±0.25mm(X.XXX in.±0.010 in.)



MECHANICAL DRAWING (WITHOUT HEAT SPREADER)



<u>SIDE VIEW</u>

NOTES:

DIMENSIONS ARE IN MILLIMETERS AND (INCHES)
TOLERANCES: X.Xmm±0.5mm(X.XX in.±0.02 in.)
X.XXmm±0.25mm(X.XXX in.±0.010 in.)

Pin No. Name		<u>Function</u>		
1	+Vin	Positive input voltage		
2	ON/OFF	Remote ON/OFF		
3	Case	Optional		
4	-Vin	Negative input voltage		
5	-Vout	Negative output voltage		
6	+Vout	Positive output voltage		

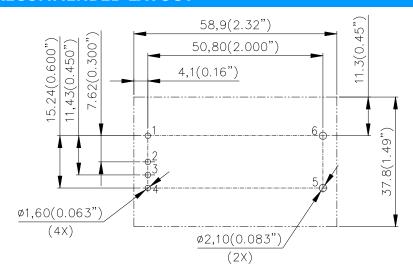
Pin Specification:

Pins 1-4 1.00mm (0.040") diameter Pins 5 &6 1.50mm (0.059") diameter

All pins are copper with Tin plating and Nickel under plating.



RECOMMENDED LAYOUT



PIN	NAME
1	Vin(+)
2	ON/OFF
3	case(option)
4	Vin(-)
5	Vout(-)
6	Vout(+)
	1 2 3 4 5



PART NUMBERING SYSTEM									
Q	48	S	E	120	33	N	R	F	A
Form	Input	Number of	Product	Output	Output	ON/OFF	Pin		Option Code
Factor	Voltage	Outputs	Series	Voltage	Current	Logic	Length		
Q -	48-38V~75V	S - Single	E- QB high	120 –	33 - 33A	N - Negative	K - 0.110"	F - RoHS 6/6	A - Std. Functions without
Quarter			power	11.8V		P - Positive	N - 0.146"	(Lead Free)	case pin
Brick			series				R - 0.170"	Space - RoHS5/6	H - with heat spreader and
							C - 0.181"		case pin
							S - 0.189"		N - with heat spreader and
							T - 0.220"		without case pin
							L - 0.248"		

MODEL LIST								
MODEL NAME	INPUT		OUTPUT		EFF @ 100% LOAD			
Q48SE12033NRFA	38V~75V	13A	11.8V	33A	95.5%			
Q48SE12033NRFH	38V~75V	13A	11.8V	33A	95.5%			
Q48SE12033NNFH	38V~75V	13A	11.8V	33A	95.5%			

Default remote on/off logic is negative and pin length is 0.170"

For different remote on/off logic and pin length, please refer to part numbering system above or contact your local sales

CONTACT: www.deltaww.com/dcdc

USA: Telephone:

East Coast: 978-656-3993 West Coast: 510-668-5100

Fax: (978) 656 3964

Email: DCDC@delta-corp.com

Europe:

Phone: +31-20-655-0967 Fax: +31-20-655-0967 Email: <u>DCDC@delta-es.com</u> Asia & the rest of world:

Telephone: +886 3 4526107 ext 6220~6224 Fax: +886 3 4513485

Email: DCDC@delta.com.tw

WARRANTY

Delta offers a two (2) year limited warranty. Complete warranty information is listed on our web site or is available upon request from Delta.

Information furnished by Delta is believed to be accurate and reliable. However, no responsibility is assumed by Delta for its use, nor for any infringements of patents or other rights of third parties, which may result from its use. No license is granted by implication or otherwise under any patent or patent rights of Delta. Delta reserves the right to revise these specifications at any time, without notice.

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